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| 1 | <u>STIPULATION</u> | | |
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| 2 | Defendants Advanced Micro Devices, Inc., Spansion Inc., Spansion Technology Inc., | | |
| 3 | Spansion LLC, Advanced Semiconductor Engineering, Inc., ASE (U.S.) Inc., ChipMOS | | |
| 4 | Technologies Inc., ChipMOS U.S.A., Inc., Siliconware Precision Industries Co., Ltd., | | |
| 5 | Siliconware, USA Inc., STMicroelectronics N.V., STMicroelectronics, Inc., Stats ChipPAC Ltd., | | |
| 6 | Stats ChipPAC, Inc. and Stats ChipPAC (BVI) Limited (collectively, "Defendants"), and Plaintiff | | |
| 7 | Tessera, Inc. ("Tessera") hereby stipulate as follows: | | |
| 8 | WHEREAS, the Court's June 23, 2006 Order (Document 142, Order on Defendants' | | |
| 9 | Motion to Strike Tessera's Patent Local Rule 3-1 Initial Disclosures; Defendants' Production of | | |
| 10 | Documents; and Tessera's Motion to Seal), states, in paragraph 4, that no later than ten (10) days | | |
| 11 | after Defendants serve their Preliminary Invalidity Contentions, the parties shall exchange their | | |
| 12 | Proposed Terms and Claim Elements for Construction pursuant to Patent L.R. 4-1; | | |
| 13 | WHEREAS, the Court's June 23, 2006 Order also states, in paragraph 5, that no later than | | |
| 14 | twenty (20) days after the parties exchange their Proposed Terms and Claim Elements for | | |
| 15 | Construction pursuant to Patent L.R. 4-1, the parties shall exchange their Preliminary Claim | | |
| 16 | Constructions and Extrinsic Evidence pursuant to Patent L.R. 4-2; | | |
| 17 | WHEREAS, Defendants served their Preliminary Invalidity Contentions on August 29, | | |
| 18 | 2006; their Proposed Terms and Claim Elements for Construction on September 13, 2006; and | | |
| 19 | their Amended Proposed Terms and Claim Elements for Construction on September 14, 2006; | | |
| 20 | WHEREAS, on September 18, 2006, Tessera provided a letter to Defendants stating that | | |
| 21 | there are no claim terms, phrases, or clauses that Tessera believes should be construed by the | | |
| 22 | Court that were not already listed amongst Defendants' Amended Proposed Terms and Claim | | |
| 23 | Elements for Construction; | | |
| 24 | WHEREAS, Defendants seek additional time to meet and confer with Tessera for the | | |
| 25 | purposes of finalizing, narrowing, or resolving differences regarding their Proposed Terms and | | |
| 26 | Claim Elements for Construction, pursuant to Patent L.R. 4-1(b); and | | |
| 27 | THEREFORE, Defendants and Tessera hereby notify the Court pursuant to Civ. L.R. 6-2 | | |
| 28 | that they request the following modifications to the Court's June 23, 2006 Order: | | |

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| 1 | 1. Defendants shall pro | ovide to Tessera their Revised Proposed Terms and Claim |
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| 2 | Elements for Construction on Octo | ber 11, 2006. Tessera shall inform Defendants of any |
| 3 | additional Proposed Terms and Cla | im Elements for Construction by October 13, 2006. |
| 4 | 2. Defendants and Tess | sera shall exchange their Preliminary Claim Constructions and |
| 5 | Extrinsic Evidence, pursuant to Pat | ent L.R. 4-2(a)-(b), by October 23, 2006 or at an earlier date to |
| 6 | be determined by agreement of the | parties. |
| 7 | | |
| 8 | D . 1 0 . 1 . 0 2006 | 77. ' T |
| 9 | Dated: October 9, 2006 | Kai Tseng Michael F. Heafey |
| 10 | | Hsiang H. Lin ORRICK, HERRINGTON & SUTCLIFFE LLP |
| 11 | | Dru Haiona II Lin /a/ |
| 12 | | By: Hsiang H. Lin /s/ Hsiang H. Lin |
| 13 | | Attorneys for Defendants SILICONWARE PRECISION INDUSTRIES CO., |
| 14 | | LTD. and SILICONWARE USA, INC. |
| 15 | Dated: October 9, 2006 | Francis J. Torrence |
| 16 | | Alan L. Unikel SEYFARTH SHAW LLP |
| 17 | | |
| 18 | | By: Alan L. Unikel /s/ Alan L. Unikel |
| 19 | | Attorneys for Defendants |
| 20 | | CHIPMOS U.S.A., INC. and CHIPMOS TECHNOLOGIES, INC. |
| 21 | Dated: October 9, 2006 | Russell L. Johnson |
| 22 | Dated. Getober 9, 2000 | Edward V. Anderson Teague I. Donahey |
| 23 | | SIDLEY AUSTIN LLP |
| 24 | | By: Russell L. Johnson /s/ |
| 25 | | By: Russell L. Johnson /s/ Russell L. Johnson |
| 26 | | Attorneys for Defendants STMICROELECTRONICS, INC. and |
| 27 | | STMICROELECTRONICS N.V. |
| 28 | | |

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| 1 | | |
| 2 | Dated: October 9, 2006 | Michael J. Bettinger Timothy P. Walker |
| 3 | | Stephen M. Everett Elaine Y. Chow |
| 4 | | PRESTON GATES & ELLIS, LLP |
| 5 | | By: Stephen M. Everett /s/ Stephen M. Everett |
| 6 | | |
| 7 | | Attorneys for Defendants ADVANCED MICRO DEVICES, INC., SPANSION |
| 8 | | INC., SPANSION TECHNOLOGY INC. and SPANSION LLC |
| 9 | Dated: October 9, 2006 | Matthew D. Powers |
| 10 | , | Steven Rizzi David J. Ball, Jr. |
| 11 | | Brett E. Cooper Michael R. Franzinger |
| 12 | | WEIL, GOTSHAL & MANGES LLP |
| 13 | | By: Michael R. Franzinger /s/ |
| 14 | | Michael R. Franzinger |
| 15 | | Attorneys for Defendants ADVANCED SEMICONDUCTOR ENGINEERING, INC., ASE (U.S.) INC., STATS CHIPPAC (BVI) |
| 16 | | LIMITED, STATS CHIPPAC, INC., and STATS CHIPPAC LTD. |
| 17 18 | Dated: October 9, 2006 | Ellisen Turner IRELL & MANELLA LLP |
| 19 | | |
| 20 | | By: Ellisen Turner /s/ Ellisen Turner |
| 21 | | Attorneys for Plaintiff |
| 22 | | TESŠERA, INC. |
| 23 | | |
| 24 | | |
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| 27 | | |
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| | | STIPULATION AND [PROPOSED] ORDER TO MODIFY DEADLINE TO EXCHANGE PATENT LOCAL RULE 4-2 |

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| 1 | SIGNATURE ATTESTATION |
|----------|--|
| 2 | I hereby attest that I have on file all holograph signatures and/or written concurrences for |
| 3 | any signature indicated by a "conformed" signature (/s/) within this efiled document. |
| 4 | |
| 5 | Heisma H. Lim /s/ |
| 6 | Hsiang H. Lin /s/ Hsiang H. Lin |
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